TOSHIBA Photocoupler IRED & Photo-Transistor

# TLP621,TLP621-2,TLP621-4

Programmable Controller AC / DC-Input Module Solid State Relay

The TOSHIBA TLP621, -2 and -4 consists of a photo-transistor optically coupled to an infrared emitting diode.

The TLP621–2 offers two isolated channels in an eight lead plastic DIP, which the TLP621–4 provides four isolated channels in a sixteen plastic DIP.

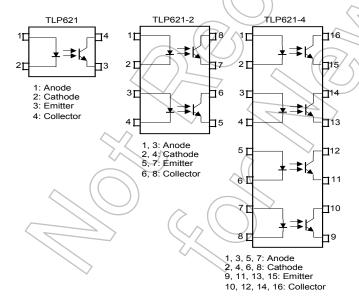
- Collector-emitter voltage: 55 V (min.)
- Current transfer ratio: 50% (min.)

Rank GB: 100% (min.)

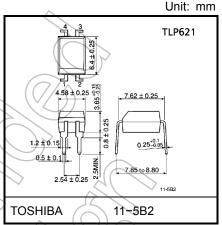
- Isolation voltage: 5000Vrms(min)
- UL-recognized: UL 1577, File No.E67349
- cUL-approved: CSA Component Acceptance Service No.5A File No.E67349
- VDE-approved: EN 60747-5-5 (Note 1)

Note 1 :When a VDE approved type is needed, please designate the **Option (D4)**.

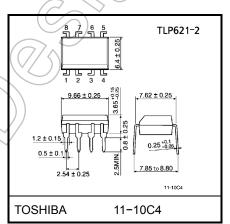
### Pin Configurations (top view)



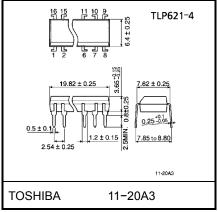
		7 62 mm nitch	10.16 mm pitch
		standard type	TLPxxxF type
•	Creepage distance	: 6.4 mm (min.) : 6.4 mm (min.) : 0.4 mm (min.)	
	Clearance	: 6.4 mm (min.)	8.0 mm (min)
	Insulation thickness	: 0.4 mm (min.)	0.4 mm (min)



Weight: 0.26 g (typ.)



Weight: 0.54 g (typ.)



Weight: 1.1 g (typ.)

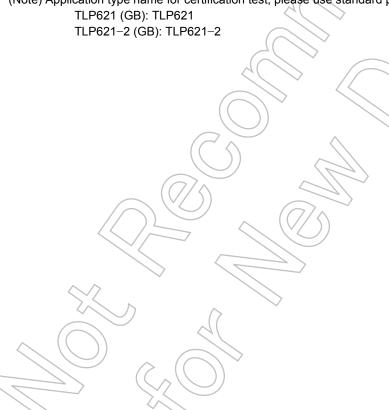
Start of commercial production 1983-02

#### • Current Transfer Ratio

Туре	Classi– fication *1	Current Transfer Ratio (%) (I <sub>C</sub> / I <sub>F</sub> )  I <sub>F</sub> = 5mA, V <sub>CE</sub> = 5V, Ta = 25°C  Min. Max.		Marking Of Classification
	(None)	50	600	Blank, Y <sup>a</sup> , YE, G, G <sup>a</sup> , GR, B, BL, GB
	Rank Y	50	150	YE, Yª
	Rank GR	100	300	GR, G, G <sup>■</sup>
	Rank BL	200	600	BL,B
TLP621	Rank GB	100	600	GB, GR, G, G <sup>■</sup> , BL, B
	Rank YH	75	150	Y*
	Rank GRL	100	200	G
	Rank GRH	150	300	G*
	Rank BLL	200	400	В
TLP621-2	(None)	50	600	Blank, GR, BL, GB
TLP621-4	Rank GB	100	600	GB, GR, BL

<sup>\*1:</sup> Ex. rank GB: TLP621 (GB)

(Note) Application type name for certification test, please use standard product type name, i.e.



#### **Absolute Maximum Ratings (Ta = 25°C)**

			Ra	ting	
	Characteristic	Symbol	TLP621	TLP621-2 TLP621-4	Unit
	Forward current	l <sub>F</sub>	60	50	mA
	Forward current derating (Note 1)	ΔIF /°C	-0.7 (Ta ≥ 39°C)	-0.5 (Ta ≥ 25°C)	mA /°C
	Pulse forward current	lfP	1 (100µs pu	lse, 100pps)	Α
ED	Power dissipation	PD	100	70	wW
	Power dissipation derating	ΔP <sub>D</sub> /°C	-1.0(Ta ≥ 39°C)	-0.7(Ta ≥ 25°C)	mW /°C
	Reverse voltage	VR	,	5 ((//))	V
	Junction temperature	Tj	12	25	°C
	Collector-emitter voltage	VCEO	55		V
	Emitter-collector voltage	V <sub>ECO</sub>			У
'n	Collector current	Ic	50		/mA
Detector	Collector power dissipation (1 circuit)	PC	150	100	mW
	Collector power dissipation derating (1 circuit, Ta ≥ 25°C)	ΔP <sub>C</sub> /°C	-1.5	-1.0	mW/°C
	Junction temperature	Tj	12	25	>,℃
Stor	rage temperature range	T <sub>stg</sub>	-55 to 125		°C
Оре	erating temperature range	T <sub>opr</sub>	-55 to 100		°C
Lead soldering temperature		T <sub>sol</sub>	260 (10.s)		°C
Total package power dissipation		PT	250	150	mW
Total package power dissipation derating (Ta ≥ 25°C)		ΔPT /°C	-2.5	-1.5	mW /°C
Isola	ation voltage (Note 2)	BVs	5000 (AC, 60 s	s., R.H.≤ 60 %)	V <sub>rms</sub>

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1:  $Pw = 100 \mu s(max)$ , f = 100 Hz

Note 2: Device considered a two terminal: LED side pins shorted together, and detector side pins shorted together.

### **Recommended Operating Conditions**

Characteristic	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	Vcc	_	5	24	V
Forward current	lF	_	16	20	mA
Collector current	Ic	_	1	10	mA
Operating temperature	T <sub>opr</sub>	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

### Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μΑ
	Capacitance	Ст	V = 0 V, f = 1 MHz	/	30	_	pF
	Collector-emitter breakdown voltage	V <sub>(BR)</sub> CEO	I <sub>C</sub> = 0.5 mA	55	7/	1	V
ctor	Emitter-collector breakdown voltage	V(BR) ECO	I <sub>E</sub> = 0.1 mA	)/	_	1	V
Detector	Collector dark current		V <sub>CE</sub> = 24 V	<i>J</i> }	10	100	nA
	Collector dark current	ICEO	V <sub>CE</sub> = 24 V, Ta = 85 °C		2	50	μΑ
	Capacitance (collector to emitter)	C <sub>CE</sub>	V = 0 V, f = 1 MHz		10		pF

### **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Condition	Mln.	Typ.	Max.	Unit
Current transfer ratio	IC / IF	I <sub>F</sub> = 5 mA, V <sub>CE</sub> = 5 V	50	>	600	%
Surrent transfer ratio		Rank GB	100	_	600	70
Saturated CTR	IC / IF (sat)	I <sub>F</sub> = 1 mA, V <sub>CE</sub> = 0.4 V	)	60	_	%
Saturated CTK		Rank GB	30	_	_	/0
	40	IC = 2.4 mA, I <sub>F</sub> = 8 mA	_	_	0.4	
Collector–emitter saturation voltage	VcE (sat)	I <sub>C</sub> = 0.2 mA, I <sub>F</sub> = 1 mA	_	0.2	_	V
	(())	Rank GB	_	_	0.4	

### Isolation Characteristics (Ta = 25°C)

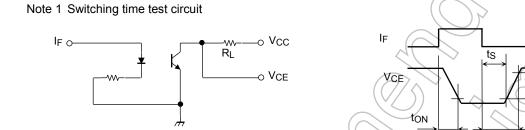
Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Capacitance (input to output)	Cs	V <sub>S</sub> = 0 V, f = 1 MHz	_	0.8	-	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	1×10 <sup>12</sup>	10 <sup>14</sup>	-	Ω
Isolation voltage	BVS	AC, 60 s	5000	_		V <sub>rms</sub>

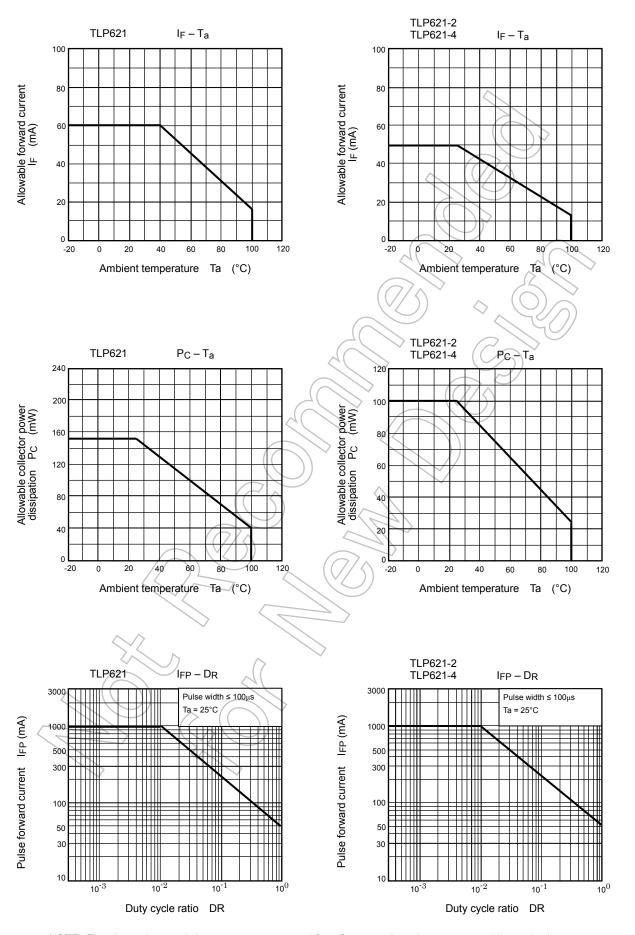
4.5V

0.5V

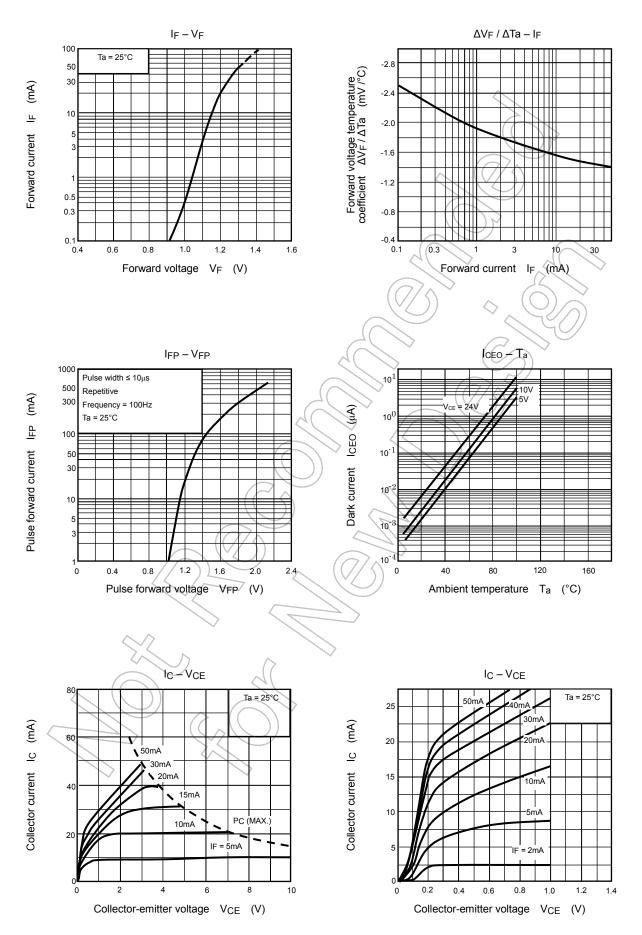
### **Switching Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Rise time	t <sub>r</sub>	V <sub>CC</sub> = 10 V, I <sub>C</sub> = 2 mA R <sub>L</sub> = 100 Ω	_	2	_	
Fall time	t <sub>f</sub>		_	3	_	
Turn-on time	ton		/-	3	_	μS
Turn-off time	toff			3	_	
Turn-on time	ton			) 2	_	
Storage time	ts	$R_L = 1.9 \text{ k}\Omega$ (Note 1) $V_{CC} = 5 \text{ V}$ , $I_F = 16 \text{ mA}$	7/	15	_	μS
Turn-off time	toff		) <del>)</del>	25	_	

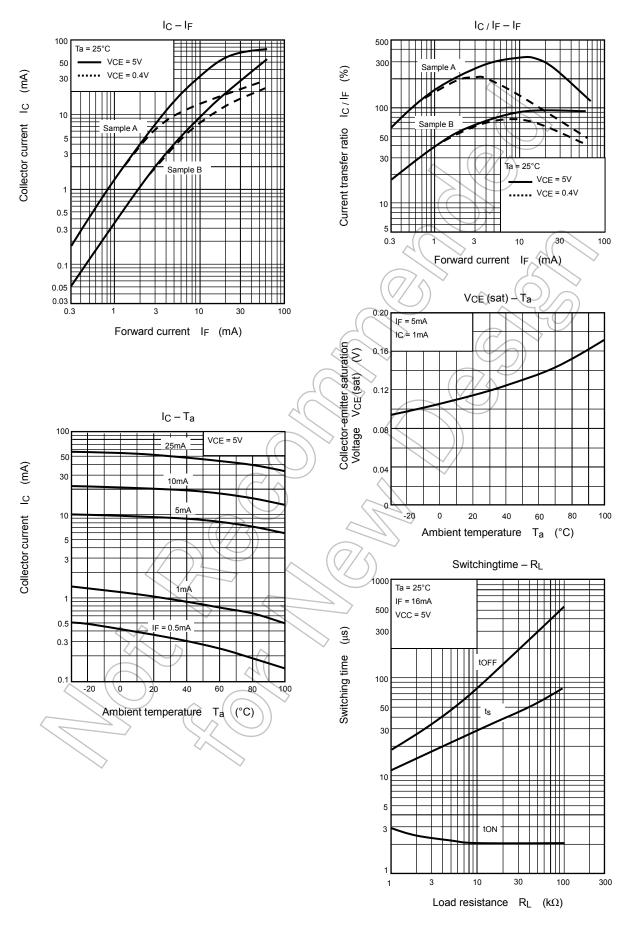




NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

#### RESTRICTIONS ON PRODUCT USE

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.
- PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE
  EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH
  MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT
  ("UNINTENDED USE"). Except for specific applications as expressly stated in this document, Unintended Use includes, without
  limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, lifesaving and/or life supporting medical
  equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to
  control combustions or explosions, safety devices, elevators and escalators, and devices related to power plant. IF YOU USE
  PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT. For details, please contact your
  TOSHIBA sales representative or contact us via our website.
- . Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any
  applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE
  FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY
  WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR
  LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND
  LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO
  SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS
  FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.
- GaAs (Gallium Arsenide) is used in Product. GaAs is harmful to humans if consumed or absorbed, whether in the form of dust or vapor. Handle with care and do not break, cut, crush, grind, dissolve chemically or otherwise expose GaAs in Product.
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without
  limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile
  technology products (mass destruction weapons). Product and related software and technology may be controlled under the
  applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the
  U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited
  except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of
  Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled
  substances, including without limitation, the EU RoHS Directive. TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES
  OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

### **TOSHIBA ELECTRONIC DEVICES & STORAGE CORPORATION**

https://toshiba.semicon-storage.com/

## **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Toshiba: